

Si Wafers



Specifications

Diameter, mm	100
Thickness, μm	380; 420; 460
Deviation from nominal value, μm	± 25
Crystallographic orientation, $^\circ$	(100); (111)
Polarity	B or P
Type	Monocrystalline silicon wafers KDB or KE F
Flat orientation	SEMI E1
Polishing	Double-sided
TTV minimum, μm	2
TTV minimum/standard, μm	до 5